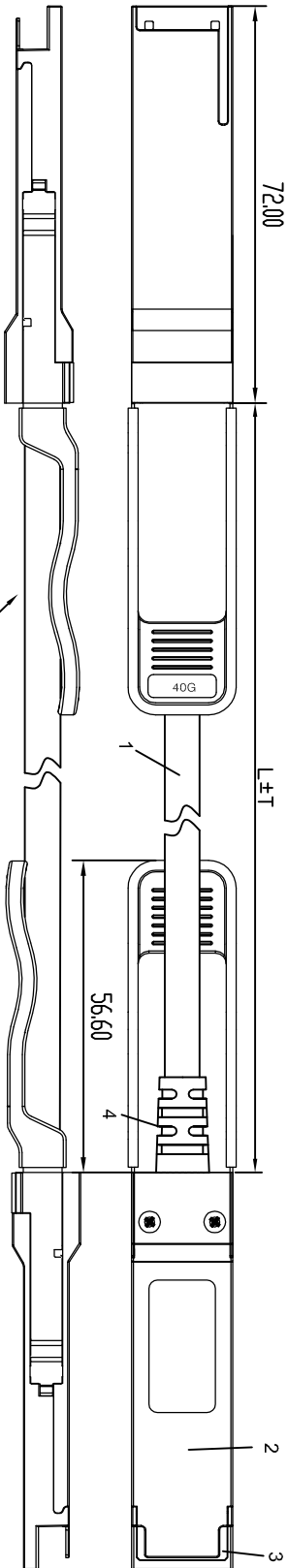
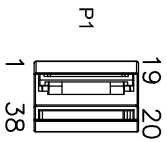


产品名称

40G 30AWG



1. CABLE:
CONDUCTOR: 30 AWG SOLID SILVER PLATED COPPER.
INSULATION: FOAM POLYOLEFIN.
PAIR: 2 SINGLES LAID FLAT AND PARALLEL.
DRAIN WIRE: 30 AWG SOLID SILVER PLATED COPPER.
PAIR SHIELD: ALUMINUM/POLYESTER TAPE, ALUMINUM SIDE FACING IN, 25% OVERLAP.
INNER SHIELD: ALUMINUM/POLYESTER TAPE, ALUMINUM SIDE FACING OUT, 25% OVERLAP.
OUTER SHIELD: 38 AWG TIN PLATED COPPER BRAID, 85% COVERAGE.
JACKET: PVC OUTER DIA: 6.50±0.15mm NOMINAL COLOR: BLACK.
DIFFERENTIAL IMPEDANCE: 100±5 OHMS @ TDR
UL LISTING: UL2027/6.

2. CONNECTOR:
P1, P2: 4X-PLUGGABLE-QSFP(SFF-8436)

- (1) P.C.B.: 4 LAYERS, FR4, 30u" HARD GOLD ON CONTACTS.
- (2) LATCH: STAINLESS STEEL WITH PULL TAB.
- (3) BACKSHELL- ZINC DIE CASTING HOOD/ NICKEL PLATING.
3. FOR INFINIBAND DDR.
4. TWO-WIRE SERIAL EEPROM MEMORY: 24C02B, 256 BYTES.
- DIGITAL MONITORING & PAGE SELECTING NOT SUPPORTED.

PACKING:

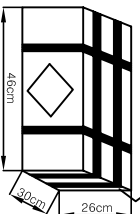
1. EVERY PRODUCT PACKED IN ANTI-STATIC BAG.
2. PACKED IN A 46*30*26CM CARTON.

P/N	L
KHC_QSFP3000500	500±30mm
KHC_QSFP3001000	1000±30mm
KHC_QSFP3001500	1500±30mm
KHC_QSFP3002000	2000±50mm
KHC_QSFP2803000	3000±50mm
KHC_QSFP2805000	4000±50mm

LABEL

Supplier: KAI HONG CHUANG
 Supplier P/N: _____
 Customer P/N: _____
 P/O Number: _____
 Quantity: _____
 EX-factory Date: _____
 Rohs:

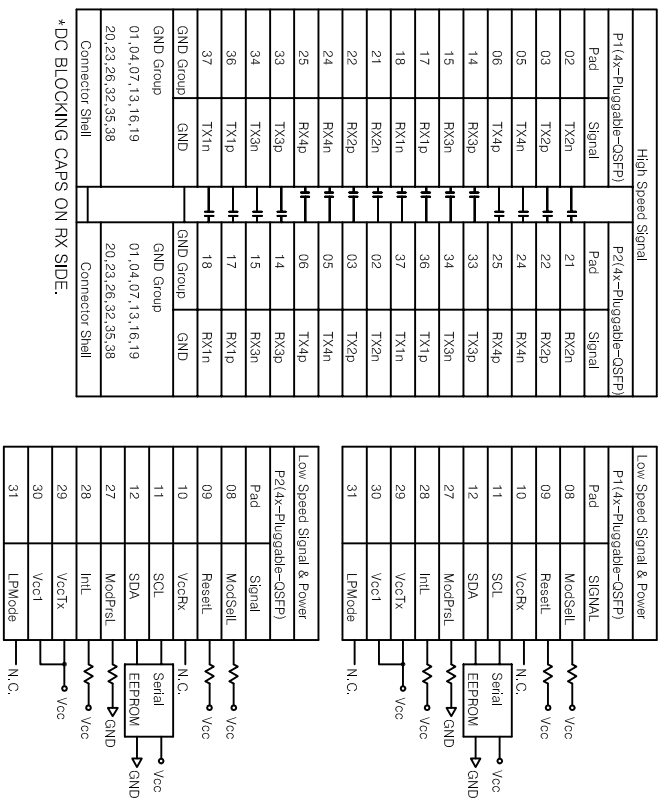
LABEL HERE



BILL OF MATERIAL:

ITEM	DESCRIPTION	QTY	UNIT
1	CABLE:UL2027/6 (30AWG*(P+D+AL))*8C+AEB BLACK OD:6.50MM	1	PCS
2	CONN: QSFP+ SHELL	2	SET
3	PCB: QSFP+ PCB	2	PCS
4	TAIL CARD BLACK	2	PCS

WIRING DIAGRAM



MATERIAL NO.: KHCQSFP30XXXXXX

CUSTOMER NO.: 40GQSFP_30AWG

APPROVED	DESIGN	STONE
REVIEW	CHECK	ELLA
SCALE 1:1	DATE	2018.08.15

DRAW NO.: 共1页 第1页